

- ◆ P-Channel Power MOS FET
- ◆ DMOS Structure
- ◆ Low On-State Resistance: **0.065Ω MAX**
- ◆ Ultra High-Speed Switching
- ◆ SOP-8 Package

Applications

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

General Description

The XP132A0265SR is a P-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOP-8 package makes high density mounting possible.

Features

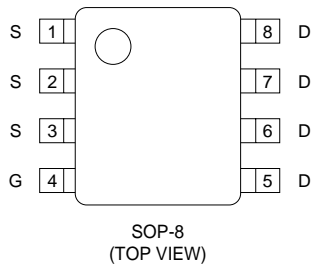
Low on-state resistance: $R_{ds(on)}=0.065\Omega(V_{gs}=-5V)$
 $R_{ds(on)}=0.12\Omega(V_{gs}=-2.5V)$

Ultra high-speed switching

Operational Voltage: -2.5V

High density mounting: SOP-8

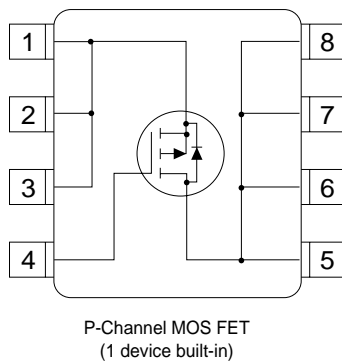
Pin Configuration



Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

Equivalent Circuit



Absolute Maximum Ratings

Ta=25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	-20	V
Gate-Source Voltage	Vgss	±12	V
Drain Current (DC)	Id	-6	A
Drain Current (Pulse)	Idp	-20	A
Reverse Drain Current	Idr	-6	A
Continuous Channel Power Dissipation (note)	Pd	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55~150	°C

Note: When implemented on a glass epoxy PCB

Electrical Characteristics

DC characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	Idss	Vds=-20V, Vgs=0V			-10	μA
Gate-Source Leakage Current	Igss	Vgs=±12V, Vds=0V			±10	μA
Gate-Source Cut-off Voltage	Vgs(off)	Id=-1mA, Vds=-10V	-0.5			V
Drain-Source On-state Resistance (note)	Rds(on)	Id=-3A, Vgs=-5V		0.055	0.065	Ω
		Id=-3A, Vgs=-2.5V		0.09	0.12	Ω
Forward Transfer Admittance (note)	Yfs	Id=-3A, Vds=-10V		8		S
Body Drain Diode Forward Voltage	Vf	If=-6A, Vgs=0V		-0.85	1.1	V

Note: Effective during pulse test.

Dynamic characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	Ciss	Vds=-10V, Vgs=0V f=1MHz		1100		pF
Output Capacitance	Coss			600		pF
Feedback Capacitance	Crss			220		pF

7

Switching characteristics

Ta=25°C

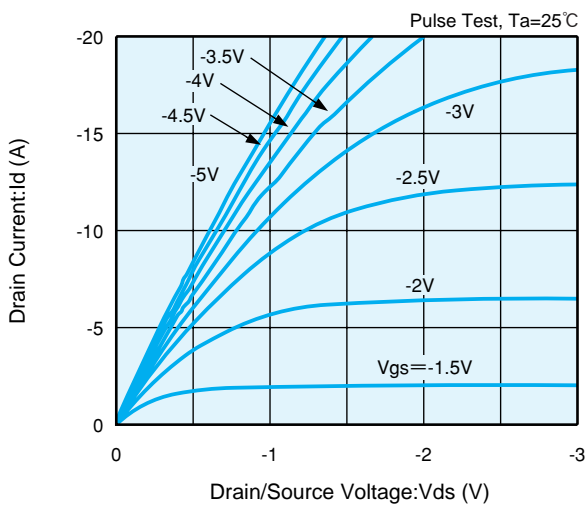
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Turn-on Delay Time	td (on)	Vgs=-5V, Id=-3A Vdd=-10V		15		ns	
Rise Time	tr			15		ns	
Turn-off Delay Time	td (off)				50		ns
Fall Time	tf				30		ns

Thermal characteristics

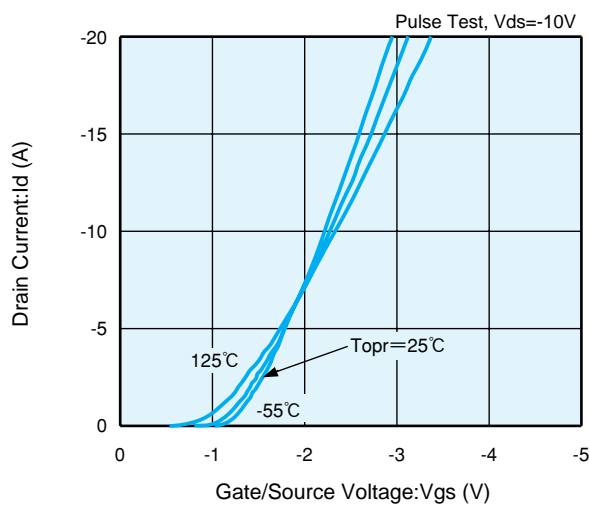
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance (channel-surroundings)	Rth (ch-a)	Implement on a glass epoxy resin PCB		50		°C/W

Electrical Characteristics

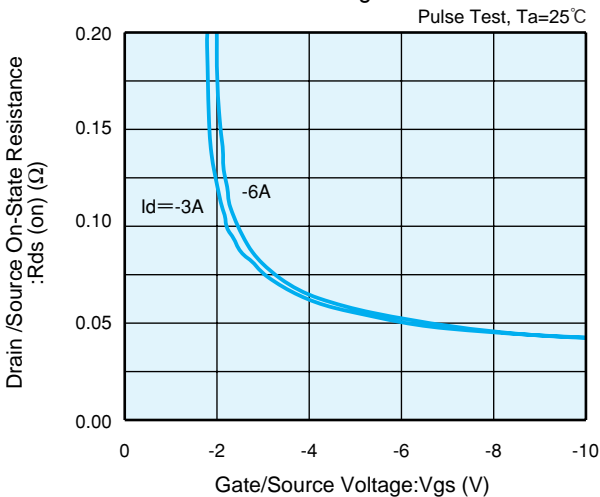
Drain Current vs. Drain /Source Voltage



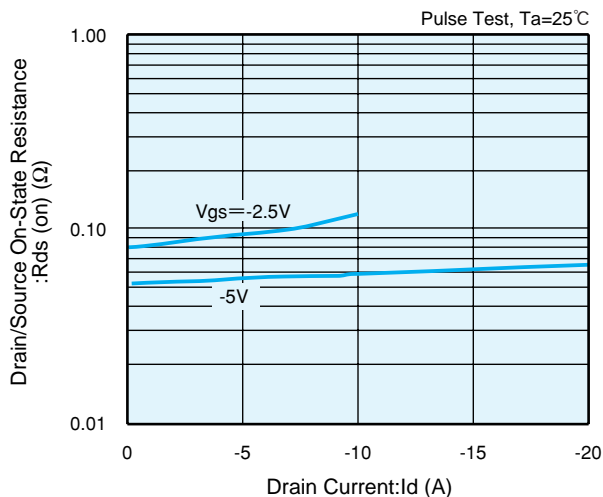
Drain Current vs. Gate/Source Voltage



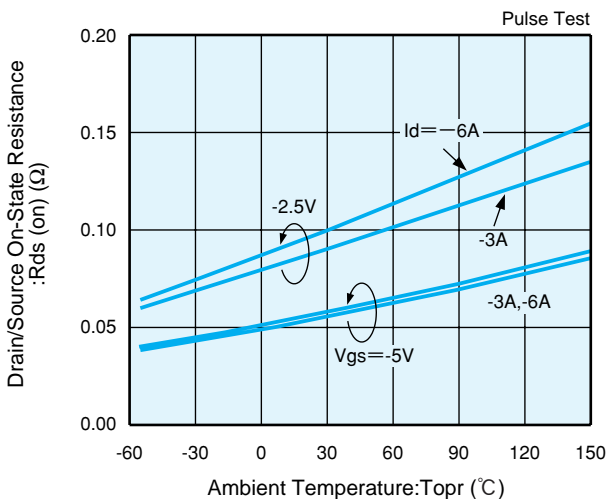
Drain/Source On-State Resistance vs. Gate/Source Voltage



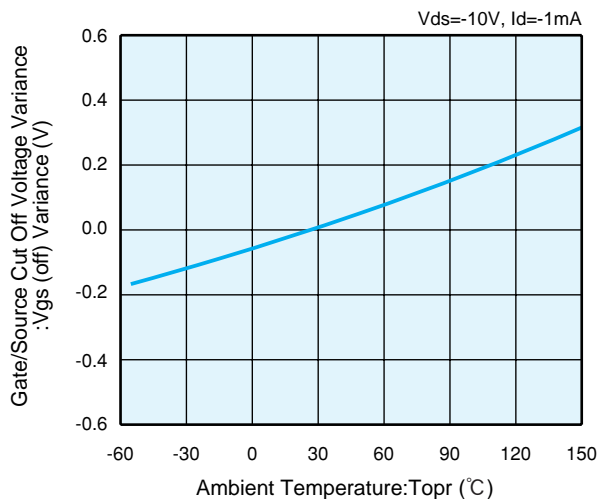
Drain/Source On-State Resistance vs. Drain Current



Drain/Source On-State Resistance vs. Ambient Temp.

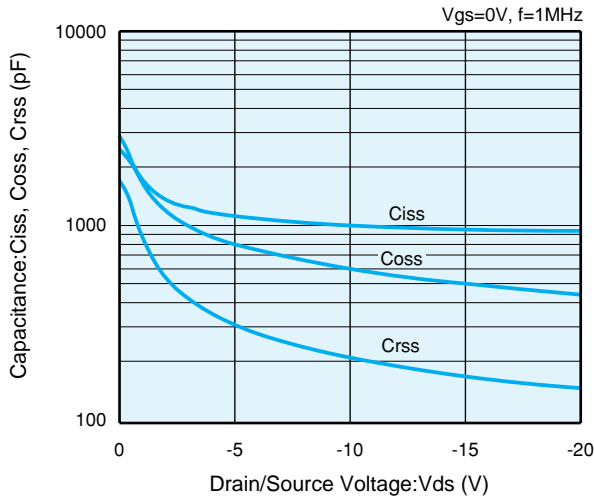


Gate/Source Cut Off Voltage Variance vs. Ambient Temp.

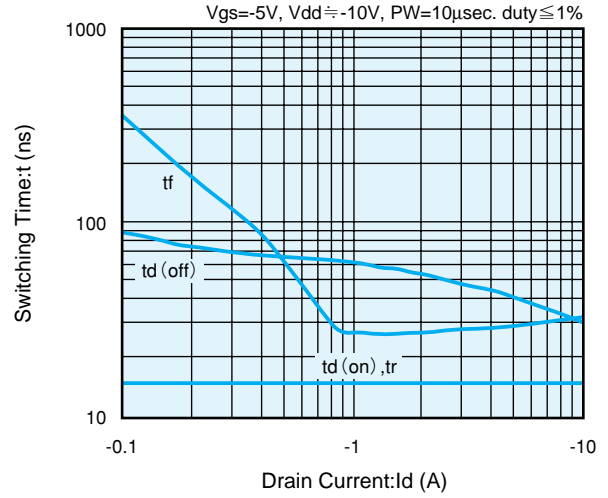


Electrical Characteristics

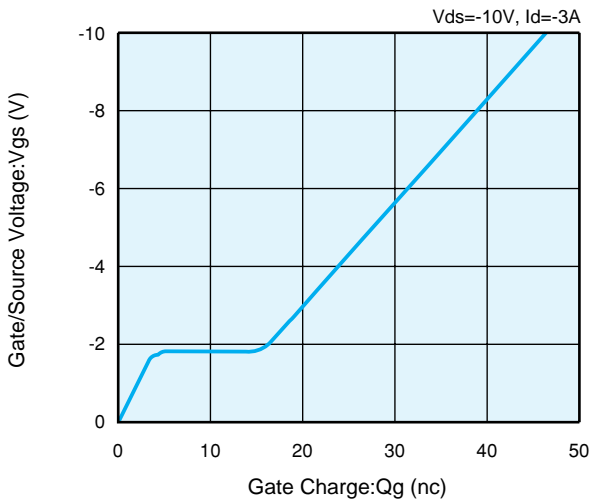
Drain/Source Voltage vs. Capacitance



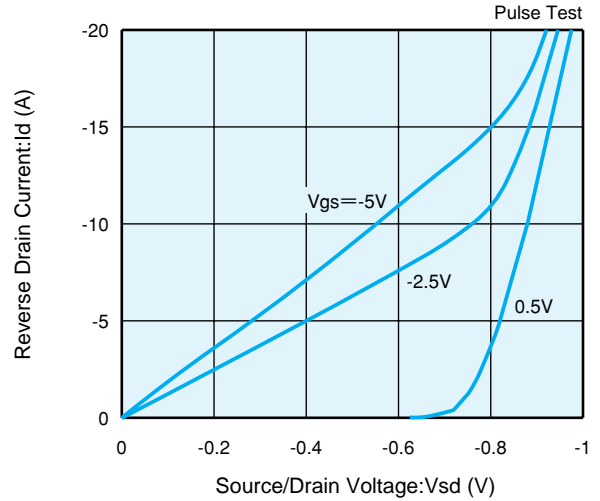
Switching Time vs. Drain Current



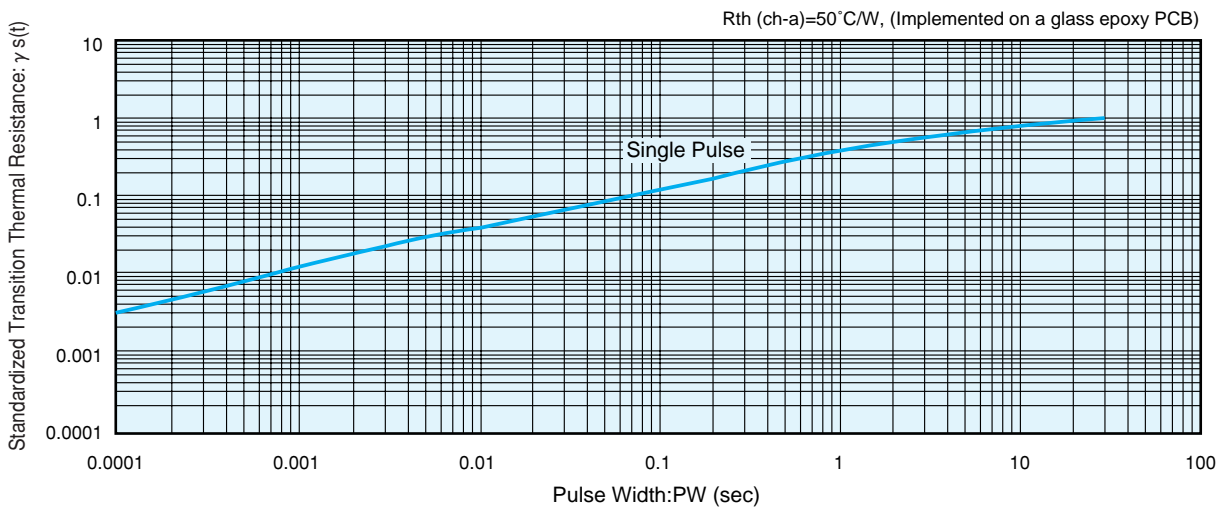
Gate/Source Voltage vs. Gate Charge



Reverse Drain Current vs. Source/Drain Voltage



Standardized Transition Thermal Resistance vs. Pulse Width



7